Duralco™ 132

500°F Thermally Conductive Epoxy

For High Power Applications

- Just Mix and Apply
- Cures at Room Temperature
- Fast Heat Transfer in any Industrial,

Electrical or Electronic Application.



Bonds Electrical Heating Element for Fluid Heating

Duralco™ 132 combines Cotronics' unique, high temperature epoxy formulation with highly conductive fillers to form thermally conductive bonds with continuous service up to 500°F.

Easy to use. Just mix, apply and cure at room temperature.

Duralco™ 132 bonds to metals, glass, ceramics, and plastics, and offers excellent resistance to chemicals, solvents and moisture.

Commonly used as a heat tracing adhesive and as a replacement for soldering and welding.

Applications Include: bonding and assembling heating coils, cooling coils, heating elements, heat sinks, reaction vessels, semi-conductors, rectifiers, power supplies, etc.

Duralco™ 132 The Ideal Choice For High Power, High Temperature, Electronic or Industrial Application Requiring High Thermal Conductivity.

Distributed By:

Physical Properties

Max. Use Temp.	500°F
Base	Aluminum
Components	2
Viscosity	45,000 cps
Density	1.9 gms/cc
Hardness	85 Shore D
Flexural Strength	1150 psi
Compressive Strength	6000 psi
Thermal Expansion	8 x 10 ⁻⁵ /°c
Thermal Conductivity	45 BTU in/hr. °F Ft. ²
Heat Distortion	210°C
Thermal Stability	0.5%
Moisture Absorption	0.2% (30 days at 50°C)
Mix Ratio (by weight)	100 /27.3

Availability:

Cat No.	Description
132-1	16 ounce kits
132-2	32 ounce kits

Available in a Non- Sag Paste Form and convenient Epox-Eez pre-measured kits and production quantities.

Prices available upon request.



COTRONICS CORPORATION